# Switchmode Series NPN Silicon Power Transistor

Designed for high-speed applications.

### Features

- Switchmode Power Supplies
- High Frequency Converters
- Relay Drivers
- Driver
- These Devices are Pb-Free and are RoHS Compliant\*

### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Rating	Symbol	Value	Unit		
Collector-Emitter Voltage	V <sub>CEO(sus)</sub>	90	Vdc		
Collector-Base Voltage	V <sub>CBO</sub>	180	Vdc		
Emitter-Base Voltage	V <sub>EBO</sub>	7.0	Vdc		
Collector Current – Continuous	۱ <sub>C</sub>	20	Adc		
Collector Current – Peak (pw 10 ms)	I <sub>CM</sub>	30	Adc		
Base Current – Continuous	Ι <sub>Β</sub>	4.0	Adc		
Base Current – Peak	I <sub>BM</sub>	6.0	Adc		
Total Power Dissipation @ $T_C = 25^{\circ}C$ $P_D$ 85Total Power Dissipation @ $T_C = 60^{\circ}C$ $P_D$ 65			≥ ≥		
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	– 65 to +175	°C		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### THERMAL CHARACTERISTICS

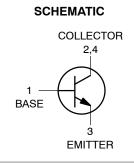
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.76	°C/W

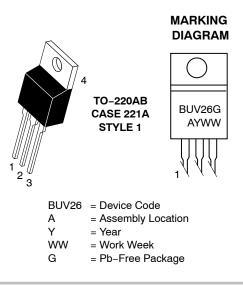


# **ON Semiconductor®**

http://onsemi.com

# 12 AMPERES NPN SILICON POWER TRANSISTORS 90 VOLTS, 85 WATTS





# ORDERING INFORMATION

Device	Package	Shipping
BUV26G	TO-220 (Pb-Free)	50 Units / Rail

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# BUV26

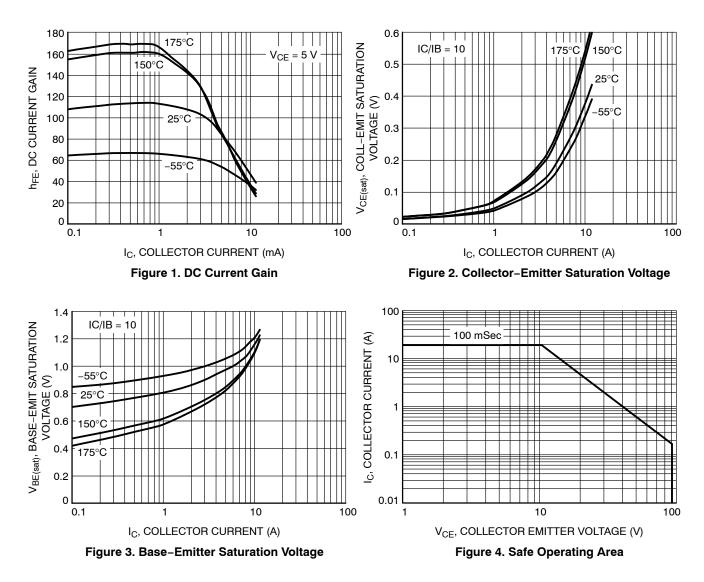
# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit	
OFF CHARACTERISTIC	S					
Collector–Emitter Susta $(I_C = 200 \text{ mA}, I_B = 0,$	5 S	V <sub>CEO(sus)</sub>	90	-	Vdc	
Collector Cutoff Curren $(V_{CE} = 180 \text{ V}, \text{ V}_{BE} =$		ICEX	_	1.0	mAdc	
Emitter Base Reverse Voltage (I <sub>E</sub> = 50 mA)		V <sub>EBO</sub>	7.0	30	V	
Emitter Cutoff Current (V <sub>EB</sub> = 5.0 V)		I <sub>EBO</sub>	_	1.0	mAdc	
Collector Cutoff Current ( $V_{CE}$ = 180 V, $R_{BE}$ = 50 $\Omega$ , $T_{C}$ = 125°C)		I <sub>CER</sub>	_	3.0	mAdc	
ON CHARACTERISTICS	3					
Collector-Emitter Saturation Voltage $(I_C = 6.0 \text{ A}, I_B = 0.4 \text{ A})$ $(I_C = 12 \text{ A}, I_B = 1.2 \text{ A})$		V <sub>CE(sat)</sub>		0.6 1.5	Vdc	
Base–Emitter Saturation Voltage $(I_C = 12 \text{ A}, I_B = 1.2 \text{ A})$		V <sub>BE(sat)</sub>	_	2.0	Vdc	
WITCHING CHARACT	ERISTICS (Resistive Load)	·				
Turn On Time	I <sub>C</sub> = 12 A, I <sub>B</sub> = 1.2 A	t <sub>on</sub>	-	0.6	μs	
Storage Time	$V_{CC} = 50 \text{ V}, \text{ V}_{BE} = 6.0 \text{ V}$	t <sub>s</sub>	-	1.0		
Fall Time	RB2 = 2.5 Ω	t <sub>f</sub>	-	0.15		
	ERISTICS (Inductive Load)	·		·		
Storage Time	$V_{CC} = 50 \text{ V}, \text{ I}_{C} = 12 \text{ A}$	T <sub>s</sub>	-	2.0	μs	
Fall Time	IB(end) = 1.2 A, VB = 5.0 V LB = 0.5 pH, TJ = 125°C	T <sub>f</sub>	-	.15		

1. Pulse Test: Pulse width  $\leq$  300 µs; Duty cycle  $\leq$  2%.

## BUV26

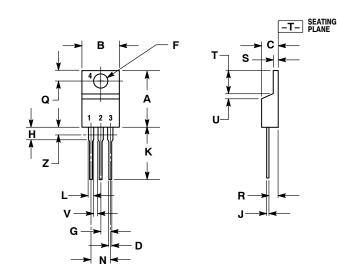




### BUV26

#### PACKAGE DIMENSIONS

#### TO-220 CASE 221A-09 **ISSUE AG**



NOTES

3

DIMENSIONING AND TOLERANCING PER ANSI 1. Y14.5M, 1982. CONTROLLING DIMENSION: INCH. 2.

DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	INCHES MILLIMETER		IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.036	0.64	0.91
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
н	0.110	0.161	2.80	4.10
J	0.014	0.025	0.36	0.64
Κ	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
۷	0.045		1.15	
Ζ		0.080		2.04

STYLE 1: PIN 1.

BASE COLLECTOR 2

EMITTER 3. COLLECTOR 4.

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